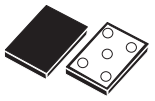
LD3985xx

Ultra low drop-low noise BiCMOS voltage regulators low ESR capacitors compatible

Features

- Input voltage from 2.5 V to 6 V
- Stable with low ESR ceramic capacitors
- Ultra low dropout voltage (100 mV typ. at 150 mA load, 0.4 mV typ. at 1 mA load)
- Very low quiescent current (85 µA typ. at no load, 170 µA typ. at 150 mA load; max 1.5 µA in OFF mode)
- Guaranteed output current up to 150 mA
- Wide range of output voltage: 1.22 V; 1.8 V; 2.5 V; 2.6 V; 2.7 V; 2.8 V; 2.9 V; 3 V; 3.3 V; 4.7 V
- Fast turn-on time: typ. 200 µs [C_O = 1 µF, C_{BYP} = 10 nF and I_O = 1 mA]
- Logic-controlled electronic shutdown
- Internal current and thermal limit
- Output low noise voltage 30 μV_{RMS} over 10 Hz to 100 kHz
- S.V.R. of 60 dB at 1 kHz, 50 dB at 10 kHz
- Temperature range: - 40 °C to 125 °C



Flip-chip (1.57x1.22)

SOT23-5L

TSOT23-5L

Description

The LD3985xx provides up to 150 mA, from 2.5 V to 6 V input voltage.

The ultra low drop-voltage, low quiescent current and low noise make it suitable for low power applications and in battery powered systems. Regulator ground current increases only slightly in dropout, further prolonging the battery life. Power supply rejection is better than 60 dB at low frequencies and starts to roll off at 10 kHz. High power supply rejection is maintained down to low input voltage levels common to battery operated circuits. Shutdown logic control function is available, this means that when the device is used as local regulator, it is possible to put a part of the board in standby, decreasing the total power consumption. The LD3985xx is designed to work with low ESR ceramic capacitors. Typical applications are in mobile phone and similar battery powered wireless systems.

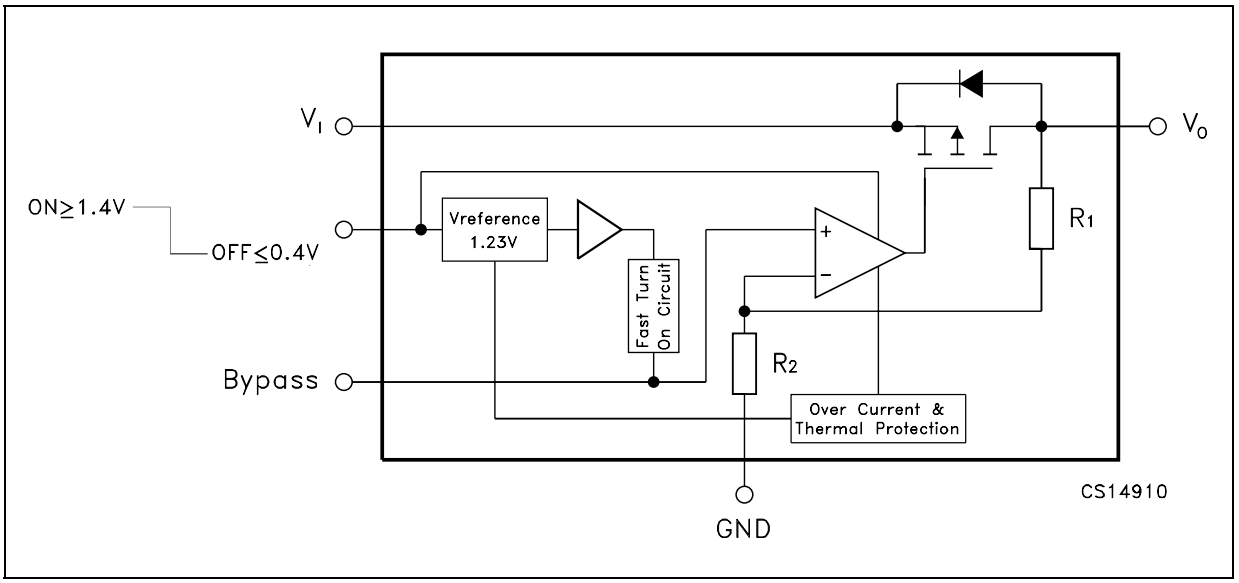
Table 1. Device summary

Part numbers	
LD3985XX122	LD3985XX28
LD3985XX18	LD3985XX29
LD3985XX25	LD3985XX30
LD3985XX26	LD3985XX33
LD3985XX27	LD3985XX47

Contents

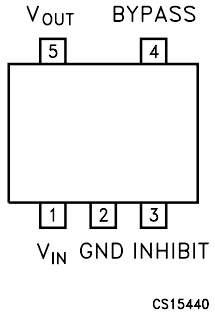
1 Diagram

Figure 1. Schematic diagram

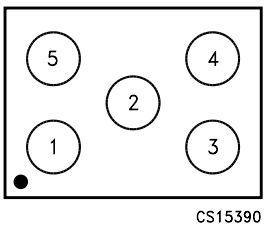


2 Pin configuration

Figure 2. Pin connections (top view for SOT and TSOT, top through view for Flip-chip)



SOT23-5L/TSOT23-5L



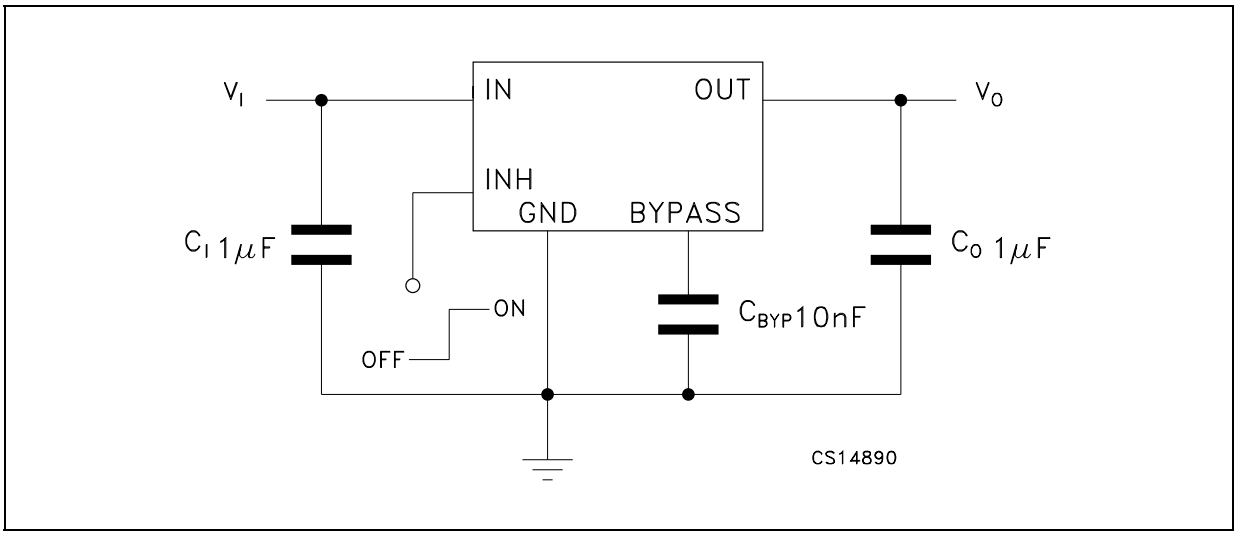
Flip-chip

Table 2. Pin description

Pin n° for SOT23-5L/ TSOT23-5L	Pin n° for Flip-chip	Symbol	Name and function
1	4	V_I	Input voltage of the LDO
2	2	GND	Common ground
3	1	V_{INH}	Inhibit input voltage: ON MODE when $V_{INH} \geq 1.2$ V, OFF MODE when $V_{INH} \leq 0.4$ V (Do not leave floating, not internally pulled down/up)
4	5	BYPASS	Bypass pin: connect an external capacitor (usually 10 nF) to minimize noise voltage
5	3	V_O	Output voltage of the LDO

3 Typical application

Figure 3. Typical application circuit



4 Maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_I	DC input voltage	-0.3 to 6 (1)	V
V_O	DC output voltage	-0.3 to V_I+0.3	V
V_{INH}	INHIBIT input voltage	-0.3 to V_I+0.3	V
I_O	Output current	Internally limited	
P_D	Power dissipation	Internally limited	
T_{STG}	Storage temperature range	-65 to 150	°C
T_{OP}	Operating junction temperature range	-40 to 125	°C

1. The input pin is able to withstand non repetitive spike of 6.5 V for 200 ms.

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

Table 4. Thermal data

Symbol	Parameter	SOT23-5L/ TSOT23	Flip-chip	Unit
R_{thJC}	Thermal resistance junction-case	81		°C/W
R_{thJA}	Thermal resistance junction-ambient	255	170	°C/W

5 Electrical characteristics

Table 5. Electrical characteristics for LD3985 (T_J = 25 °C, V_I = $V_{O(NOM)}$ +0.5 V, C_I = 1 µF, C_{BYP} = 10 nF, I_O = 1 mA, V_{INH} = 1.4 V, unless otherwise specified)

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
V_I	Operating input voltage			2.5		6	V
V_O	Output voltage < 2.5V	I_O = 1 mA		-50		50	mV
		T_J= -40 to 125°C		-75		75	
V_O	Output voltage ≥ 2.5V	I_O = 1 mA		-2		2	% of $V_{O(NOM)}$
		T_J= -40 to 125°C		-3		3	
ΔV_O	Line regulation (*Note 1*)	V_I = $V_{O(NOM)}$ + 0.5 to 6 V T_J= -40 to 125°C		-0.1		0.1	%/V
		V_O = 4.7 to 5V		-0.19		0.19	
ΔV_O	Load regulation	I_O = 1 mA to 150mA, V_O < 2.5V T_J= -40 to 125°C			0.002	0.008	%/mA
ΔV_O	Load regulation	I_O = 1 mA to 150mA, V_O ≥ 2.5V T_J= -40 to 125°C (for flip-chip)			0.0004	0.002	%/mA
		I_O = 1 mA to 150mA, T_J= -40 to 125°C (for SOT23-5L/TSOT23-5L), V_O ≥ 2.5V			0.0025	0.005	
ΔV_O	Output AC Line regulation	V_I = $V_{O(NOM)}$ + 1 V, I_O = 150mA, t_R= t_F = 30µs			1.5		mV_{PP}
I_Q	Quiescent current ON MODE: V_{INH} = 1.2V	I_O = 0			85		µA
		I_O = 0, T_J= -40 to 125°C				150	
		I_O = 0 to 150mA			170		
		I_O = 0 to 150mA, T_J= -40 to 125°C				250	
	OFF MODE: V_{INH} = 0.4V				0.003		
		T_J= -40 to 125°C				1.5	
V_{DROP}	Dropout voltage (*Note 1*)	I_O = 1mA			0.4		mV
		I_O = 1mA, T_J= -40 to 125°C				2	
		I_O = 50mA			20		
		I_O = 50mA, T_J= -40 to 125°C				35	
		I_O = 100mA			45		
		I_O = 100mA, T_J= -40 to 125°C				70	
		I_O = 150mA			60		
		I_O = 150mA, T_J= -40 to 125°C				100	
I_{SC}	Short circuit current	R_L = 0			600		mA
SVR	Supply voltage rejection	V_I = $V_{O(NOM)}$+0.25V ± V_{RIPPLE} = 0.1V, I_O= 50mA $V_{O(NOM)}$ < 2.5V, V_I = 2.55V	f = 1kHz		60		dB
			f = 10kHz		50		

Table 5. Electrical characteristics for LD3985 (continued) (T_J = 25 °C, V_I = $V_{O(NOM)}$ +0.5 V, C_I = 1 µF, C_{BYP} = 10 nF, I_O = 1 mA, V_{INH} = 1.4 V, unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{O(PK)}$	Peak output current	$V_O \geq V_{O(NOM)}$ - 5%	300	550		mA
V_{INH}	Inhibit input logic low	V_I = 2.5V to 6V, T_J= -40 to 125°C			0.4	V
	Inhibit input logic high		1.2			
I_{INH}	Inhibit input current	V_{INH} = 0.4V, V_I = 6V		±1		nA
eN	Output noise voltage	B_W = 10 Hz to 100 kHz, C_O = 1µF		30		μV_{RMS}
t_{ON}	Turn On time (*Note 4*)	C_{BYP} = 10 nF		100	250	µs
T_{SHDN}	Thermal shutdown	*Note 5*		160		°C
C_O	Output capacitor	Capacitance (*Note 6*)	1		22	µF
		ESR	5		5000	mΩ

Note: 1 For $V_{O(NOM)}$ < 2 V, V_I = 2.5 V

2 For $V_{O(NOM)}$ = 1.25 V, V_I = 2.5 V

3 Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value. This specification does not apply for input voltages below 2.5 V.

4 Turn-on time is time measured between the enable input just exceeding V_{INH} High Value and the output voltage just reaching 95 % of its nominal value

5 Typical thermal protection hysteresis is 20 °C

6 The minimum capacitor value is 1 µF, anyway the LD3985 is still stable if the compensation capacitor has a 30 % tolerance in all temperature range.

6 Typical performance characteristics

(T_J = 25 °C, $V_I = V_{O(NOM)}$ +0.5 V, $C_I = C_O$ = 1 µF, C_{BYP} = 10 nF, I_O = 1mA, V_{INH} = 1.4 V, unless otherwise specified)

Figure 4. Output voltage vs temperature

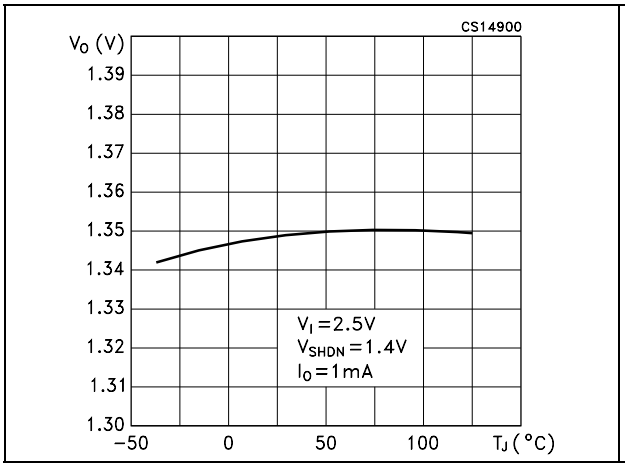


Figure 5. Output voltage vs temperature

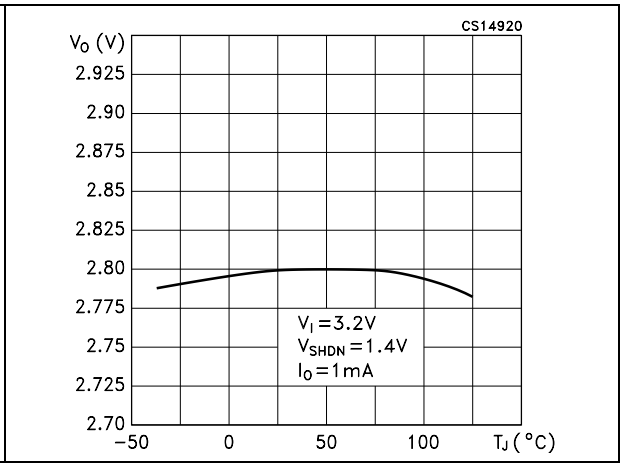


Figure 6. Output voltage vs temperature

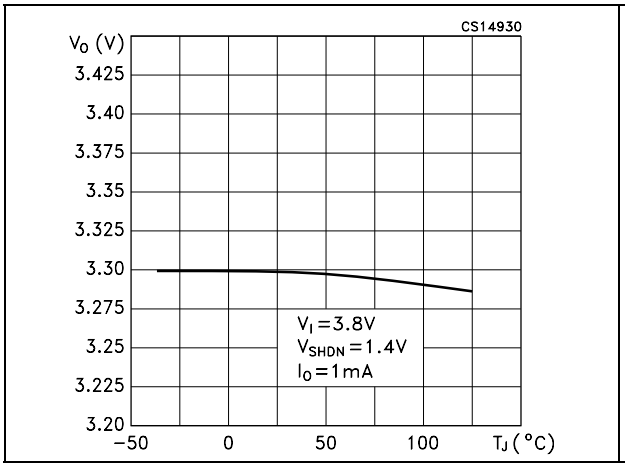


Figure 7. Shutdown voltage vs temperature

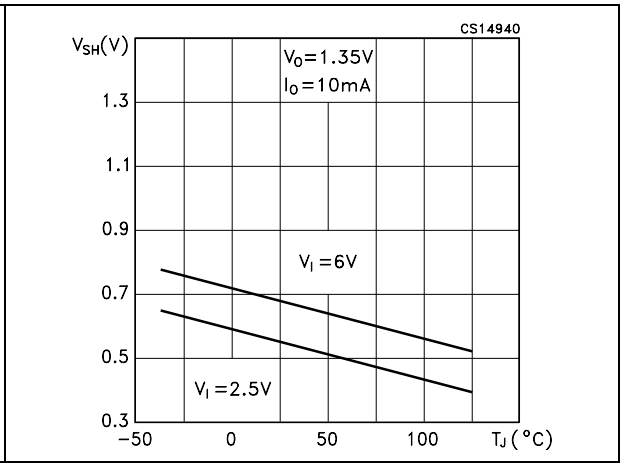


Figure 8. Shutdown voltage vs temperature

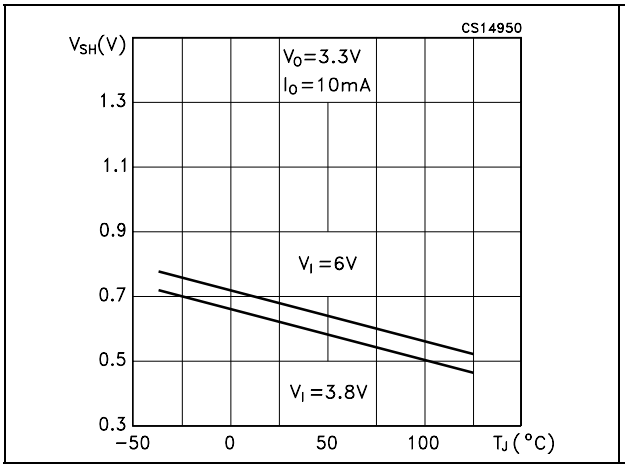


Figure 9. Line regulation vs temperature

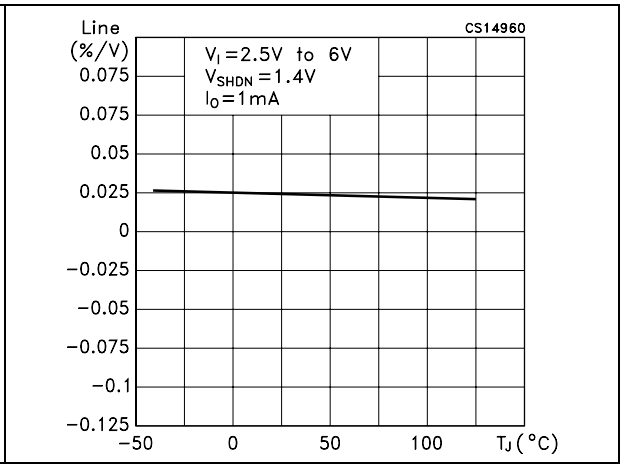


Figure 10. Line regulation vs temperature

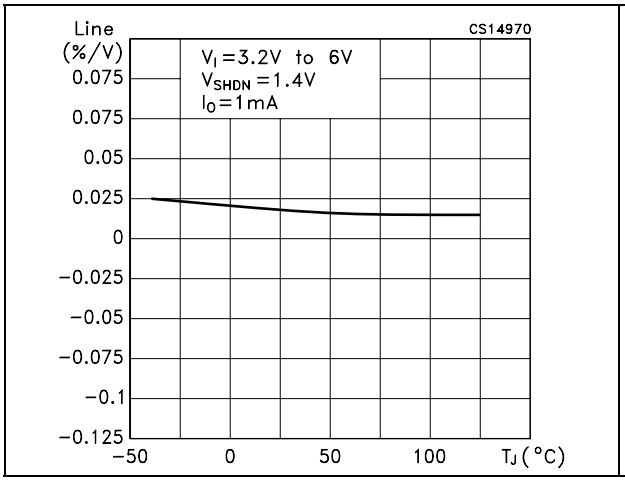


Figure 11. Line regulation vs temperature

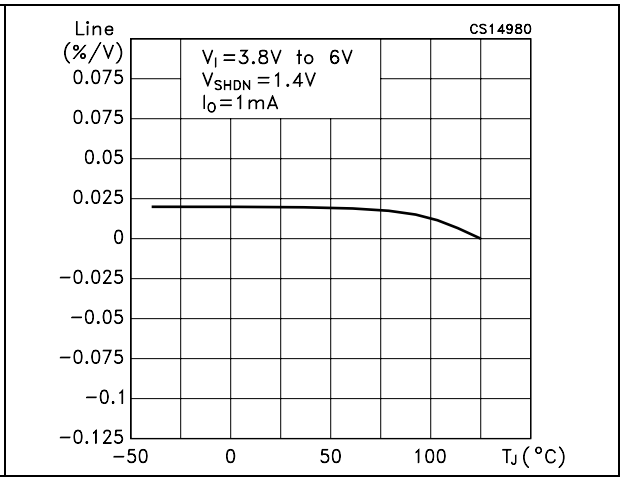


Figure 12. Load regulation vs temperature

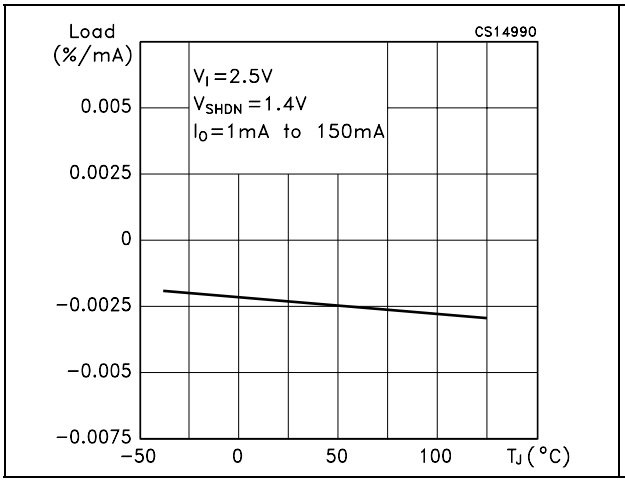


Figure 13. Load regulation vs temperature

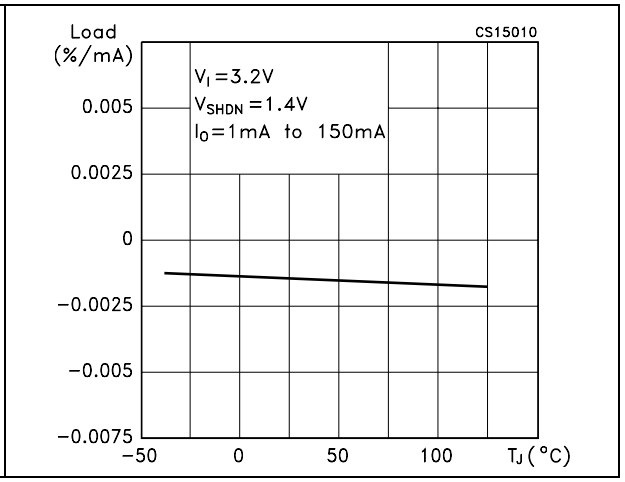


Figure 14. Load regulation vs temperature

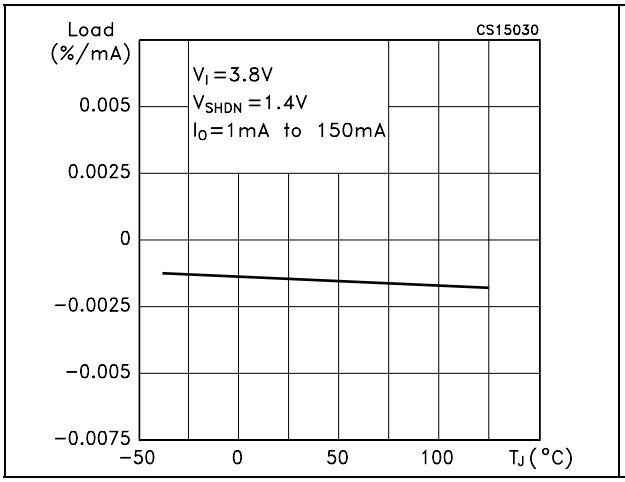


Figure 15. Quiescent current vs temperature

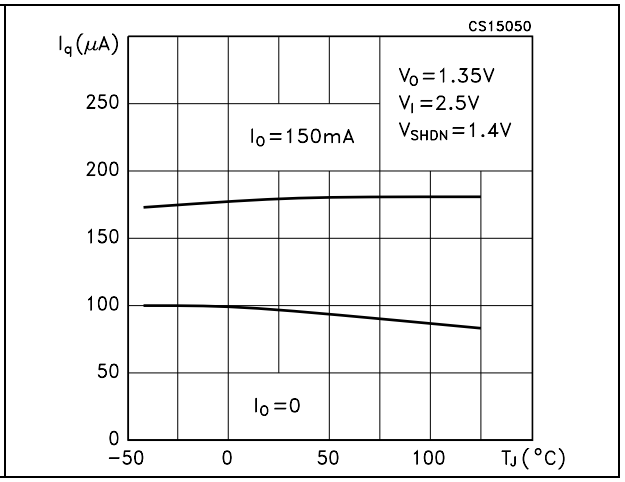


Figure 16. Quiescent current vs temperature

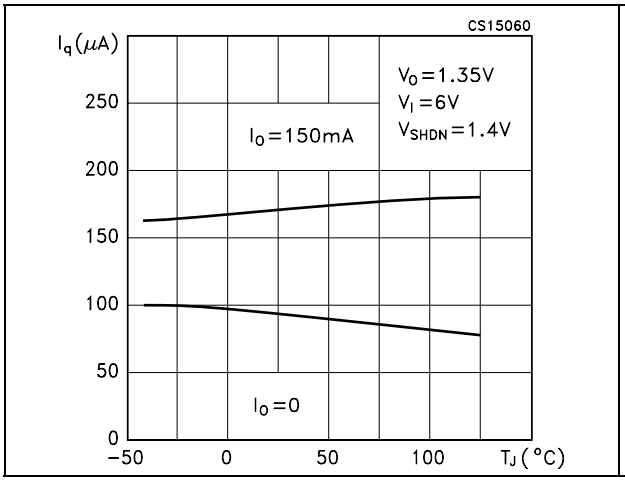


Figure 17. Quiescent current vs temperature

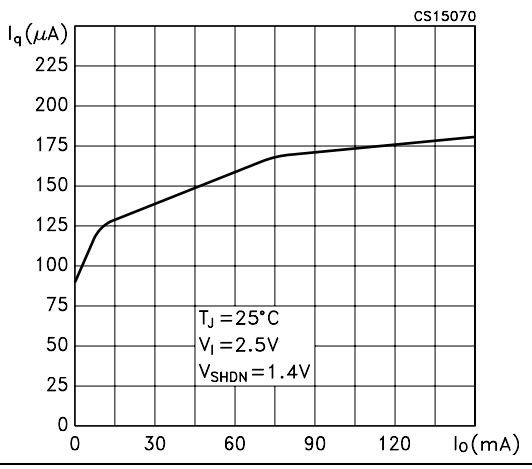


Figure 18. Supply voltage rejection vs frequency

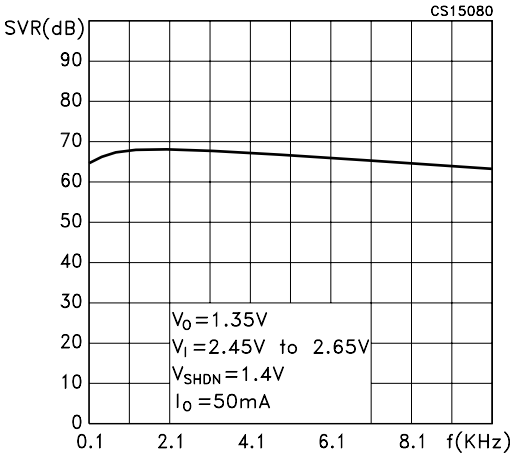
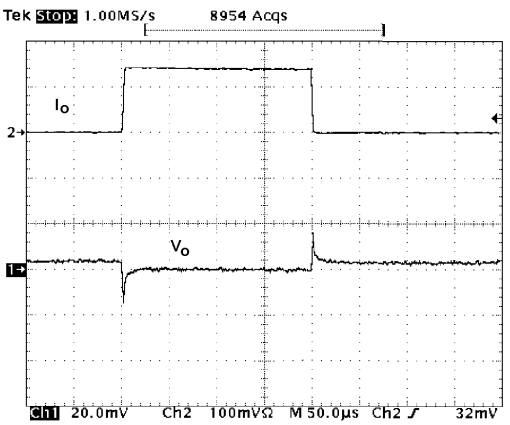
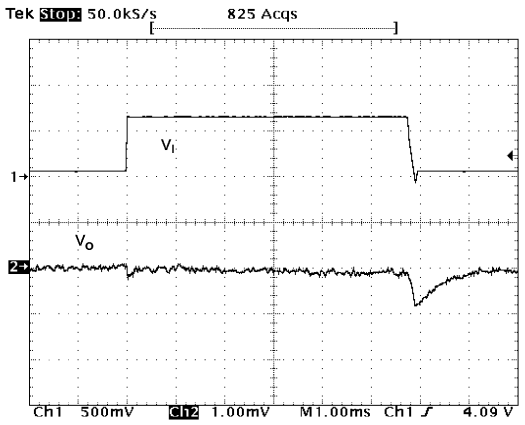


Figure 19. Load transient response



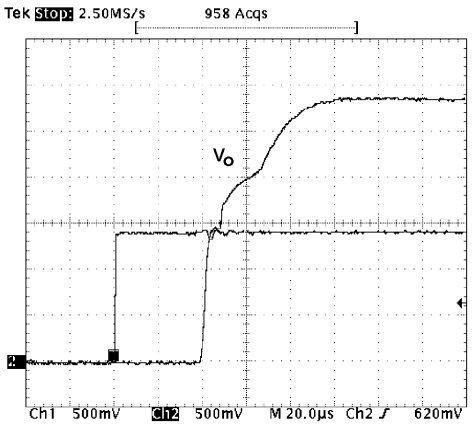
V_I = 3.2V, I_O = 1 to 150mA, Rise-Fall time = 1µsec

Figure 20. Line transient response



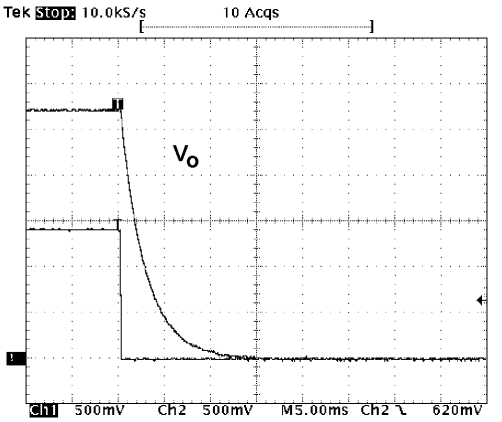
V_I = 3.8V to 4.4V, T_J = 25°C, I_O = 150mA, C_I = C_O = 1µF (X7R), C_{BYP} = 10nF, Rise-Fall time = 1µsec, V_O = 2.7V

Figure 21. Start-Up



V_I = 3.3V, I_O = 1mA, C_I = C_O = 1µF (cer), C_{BYP} = 10nF, T_r = 20ns, V_O = 2.8V

Figure 22. Turn-Off



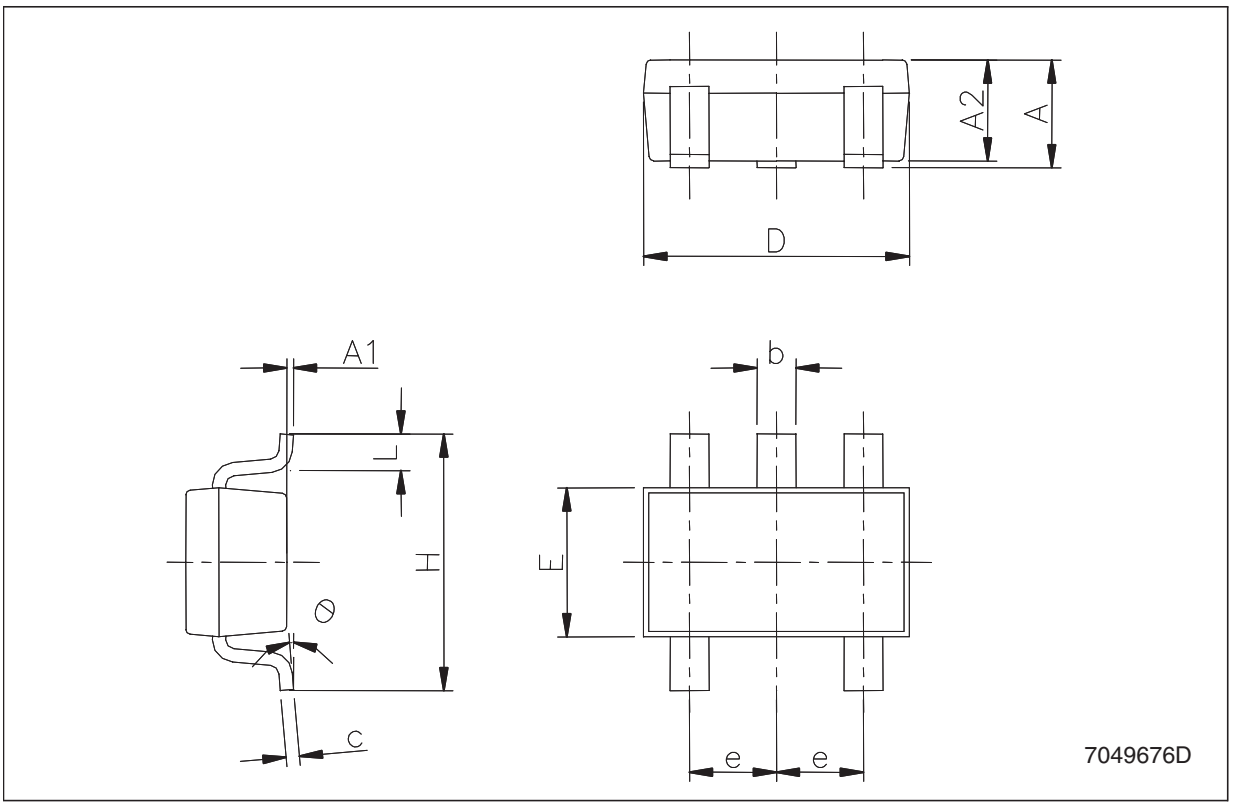
V_I = 3.3V, I_O = 1mA, C_I = C_O = 1mF (cer), C_{BYP} = 10nF, T_f = 20ns, V_O = 2.8V

7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

SOT23-5L mechanical data

Dim.	mm.			mils.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.45	35.4		57.1
A1	0.00		0.10	0.0		3.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	1.50		1.75	59.0		68.8
e		0.95			37.4	
H	2.60		3.00	102.3		118.1
L	0.10		0.60	3.9		23.6



TSOT23-5L mechanical data

Dim.	mm.			mils.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			43.3
A1	0		0.1			3.9
A2	0.7		1.0	27.6		39.4
b	0.3		0.5	11.8		19.7
C	0.08		0.2	3.1		7.9
D		2.9			114.2	
E		2.8			110.2	
E1		1.6			63.0	
e		0.95			37.4	
e1		1.9			74.8	
L	0.3		0.6	11.8		23.6

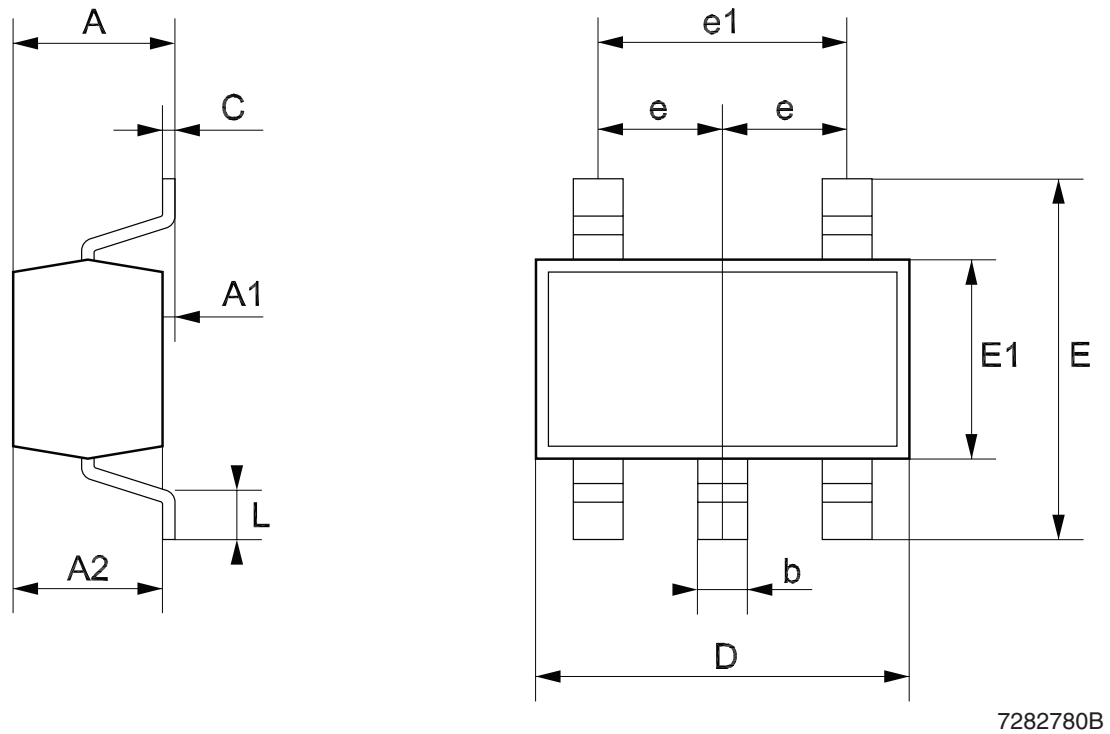
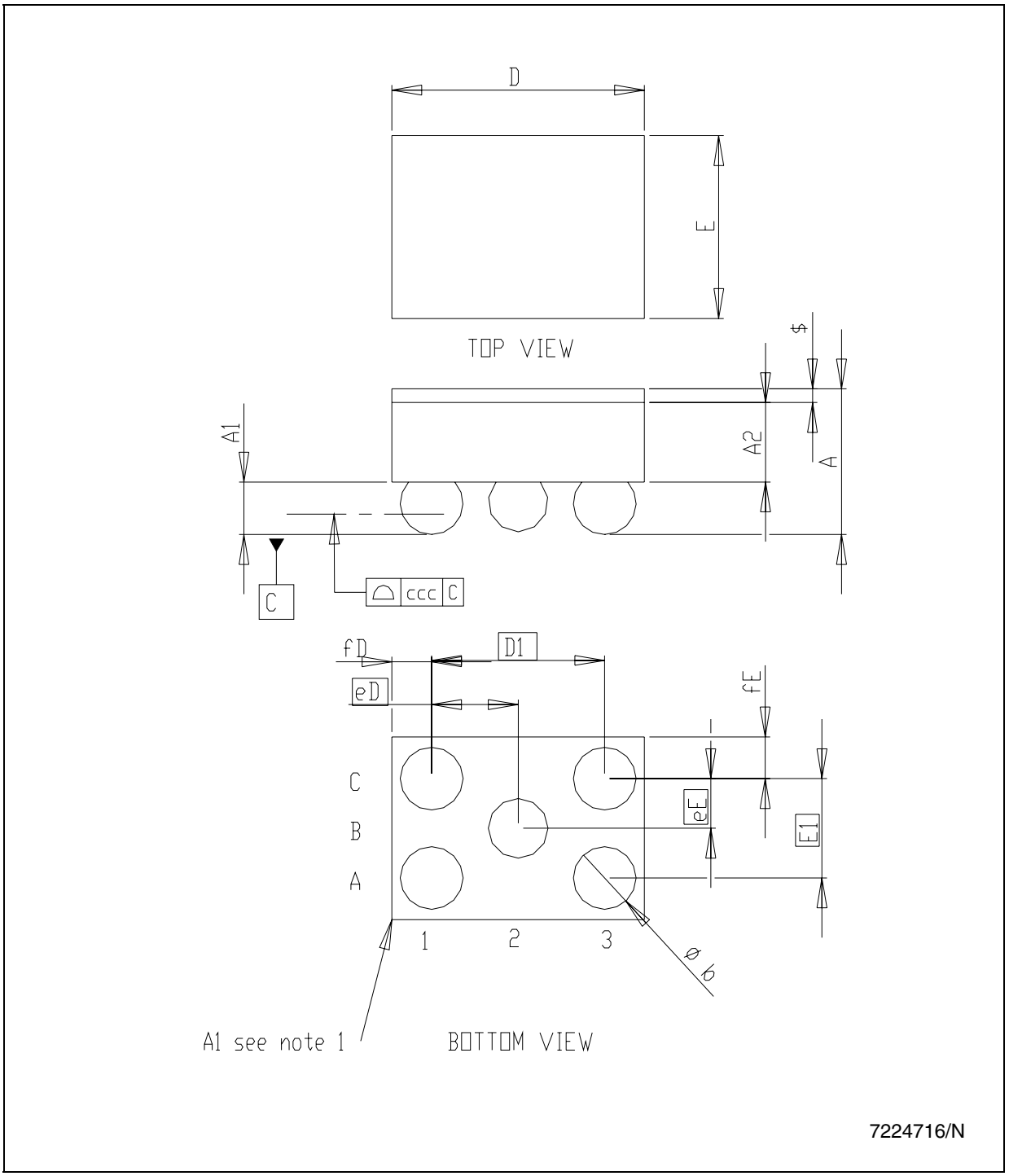


Table 6. Flip-chip 5 mechanical data

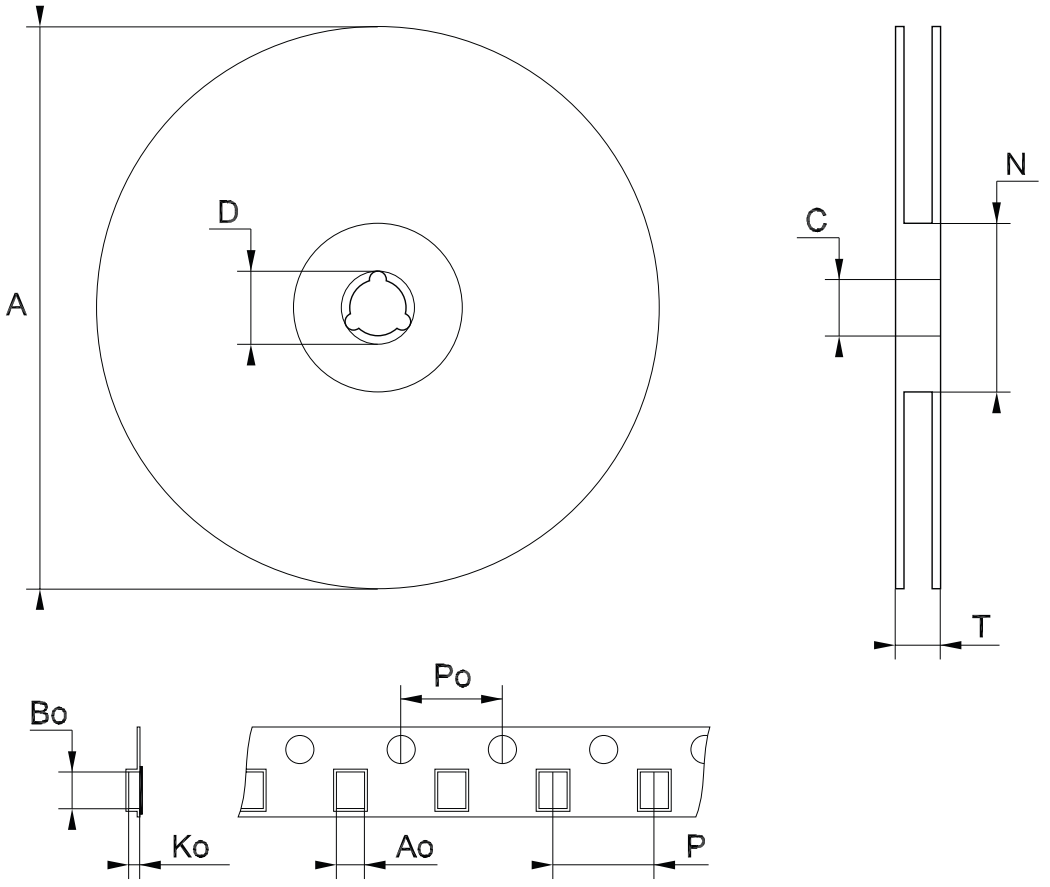
(mm.)			
Dim.	**Min.**	**Typ.**	**Max.**
A	0.54	0.65	0.66
A1	0.21	0.25	0.29
A2	0.33	0.35	0.37
b	0.265	0.315	0.365
D	1.54	1.59	1.64
D1	0.83	0.87	0.91
E	1.19	1.24	1.29
E1	0.46	0.5	0.54
eD	0.395	0.435	0.475
eE	0.21	0.25	0.29
fD		0.360	
fE		0.370	
ccc		0.080	
$		0.05	

Figure 23. Drawing dimension Flip-chip 5



Tape & reel SOT23-xL mechanical data

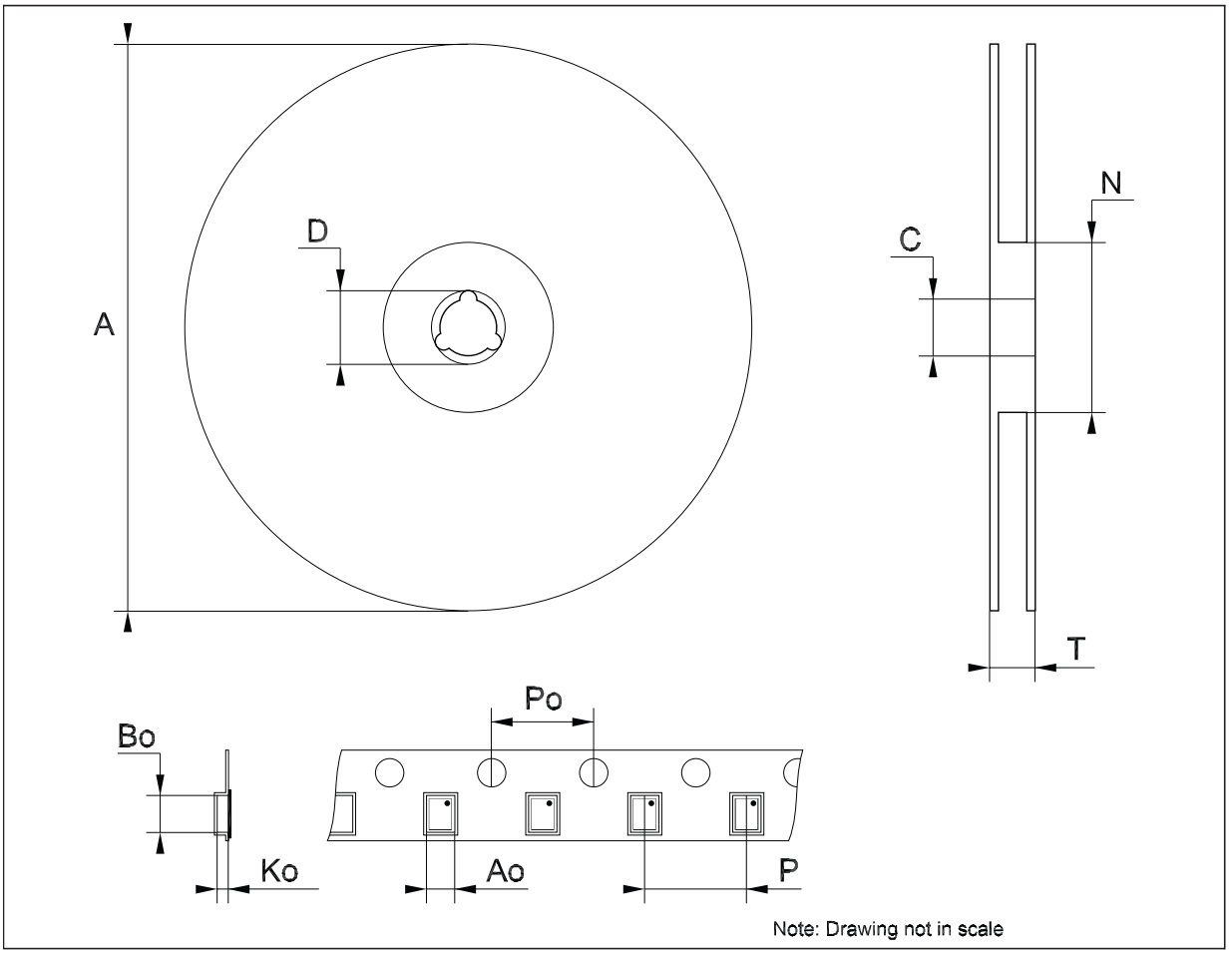
Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			180			7.086
C	12.8	13.0	13.2	0.504	0.512	0.519
D	20.2			0.795		
N	60			2.362		
T			14.4			0.567
Ao	3.13	3.23	3.33	0.123	0.127	0.131
Bo	3.07	3.17	3.27	0.120	0.124	0.128
Ko	1.27	1.37	1.47	0.050	0.054	0.0.58
Po	3.9	4.0	4.1	0.153	0.157	0.161
P	3.9	4.0	4.1	0.153	0.157	0.161



Note: Drawing not in scale

Tape & reel Flip-chip 5 mechanical data

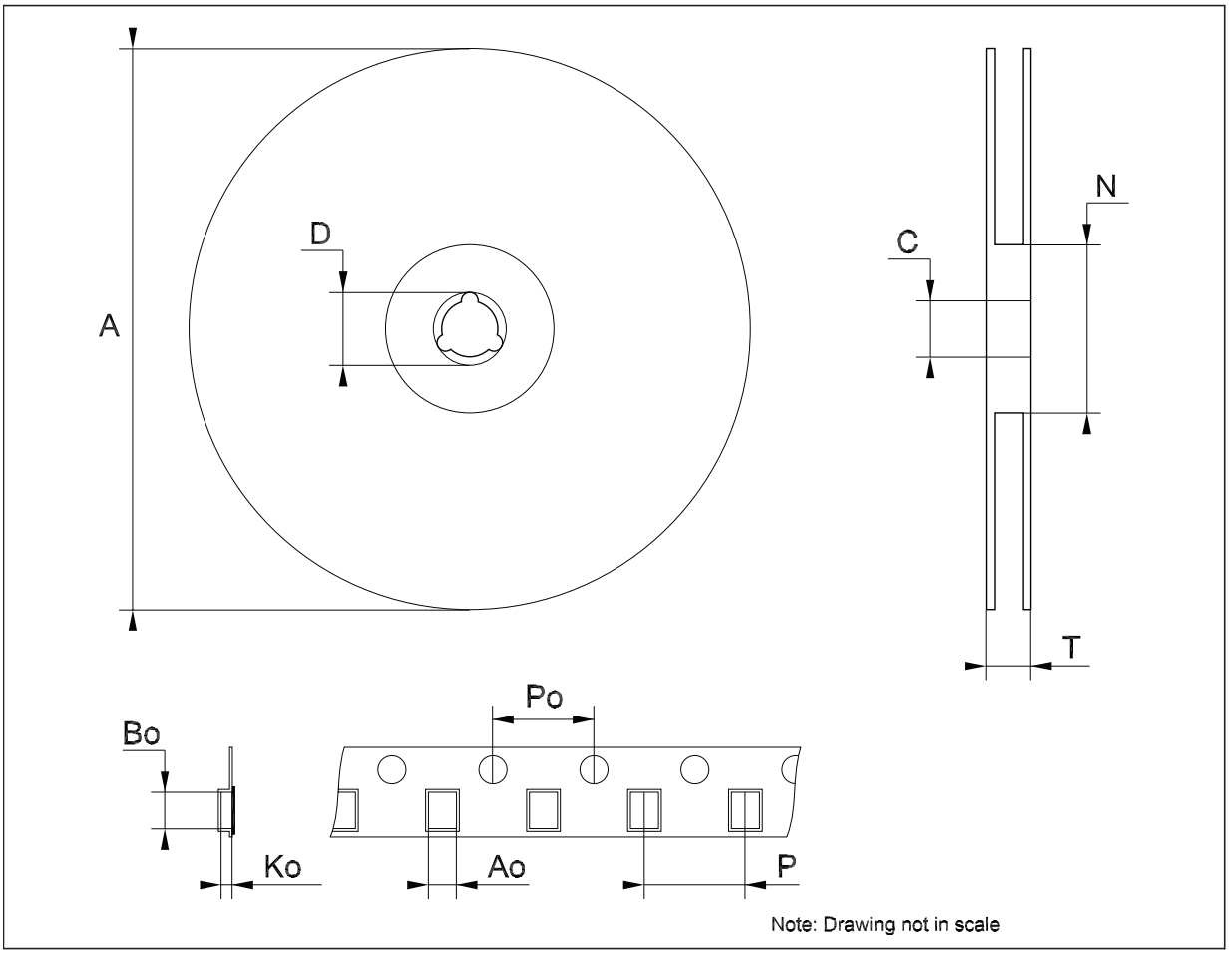
Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			178			6.926
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	49	50	51	1.929	1.969	2.008
T			12.4			0.488
Ao	1.60	1.65	1.70	0.063	0.065	0.067
Bo	1.27	1.32	1.37	0.050	0.052	0.054
Ko	0.76	0.81	0.86	0.030	0.032	0.034
Po	3.9	4	4.1	0.153	0.157	0.161
P	3.9	4	4.1	0.153	0.157	0.161



Note: Drawing not in scale

Tape & reel TSOT23-5L mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			180			7.086
C	12.8	13.0	13.2	0.504	0.512	0.519
D	20.2			0.795		
N	60			2.362		
T			14.4			0.567
Ao	3.13	3.23	3.33	0.123	0.127	0.131
Bo	3.07	3.17	3.27	0.120	0.124	0.128
Ko	1.27	1.37	1.47	0.050	0.054	0.0.58
Po	3.9	4.0	4.1	0.153	0.157	0.161
P	3.9	4.0	4.1	0.153	0.157	0.161



Note: Drawing not in scale

8 Order codes

Table 7. Order codes

Packages			
SOT23-5L	**TSOT23-5L**	**Flip-chip**	**Output voltage**
LD3985M122R	LD3985G122R (1)		1.22 V
LD3985M18R	LD3985G18R	LD3985J18R	1.8 V
LD3985M25R	LD3985G25R	LD3985J25R	2.5 V
LD3985M26R (1)	LD3985G26R (1)	LD3985J26R	2.6 V
LD3985M27R	LD3985G27R		2.7 V
LD3985M28R	LD3985G28R	LD3985J28R	2.8 V
LD3985M29R	LD3985G29R	LD3985J29R	2.9 V
LD3985M30R	LD3985G30R		3.0 V
LD3985M33R	LD3985G33R	LD3985J33R	3.3 V
LD3985M47R	LD3985G47R		4.7 V

1. Available on request.

9 Revision history

Table 8. Document revision history

Date	Revision	Changes
07-May-2004	6	Part number status changed on table 3.
05-Oct-2004	7	t_{ON} values are changed on table 5.
27-Oct-2004	8	Order codes changed - table 3.
17-Mar-2005	9	Improved drawing quality for figures 19 - 20 - 21 - 22.
10-Apr-2007	10	Order codes updated.
08-Jun-2007	11	Order code change.
20-Dec-2007	12	Modified: *Table 1*, *Table 7*, mechanical data for Flip-chip.
02-Dec-2008	13	Modified: *Table 6 on page 16* and *Figure 23 on page 17*.

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